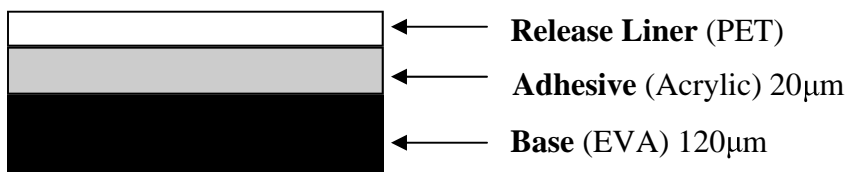


Product Datasheet

GT-117V



Characteristics

- ◆ Non-UV tape for backgrinding
- ◆ Expandability reduces wafer warpage
- ◆ Excellent adhesion to all surface materials
- ◆ Can be used on wafers with topography (small bumps, ink dots, etc.)
- ◆ No PDMS transfer to wafer surface

Specifications

<i>Property</i>	<i>Spec</i>
Total Thickness (µm)	140
Adhesive Strength (N/20mm)	1.7
Probe Tack (N/20mm²)	1.2

Product Detail

Color	Blue
Width	180/230/300mm
Length	100m
Min. Order	2 rolls

Ion Impurities

Ion	Na⁺	K⁺	PO₄²⁻	SO₄²⁻	Cl⁻
PPM	<0.05	<0.05	<0.3	<0.1	<0.1

Above data reflect limits of detection.

Warranty: 1 year from date of manufacture when stored as recommended (23 +/- 5°C, 50% RH +/- 5%)

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